	Assista	IN THE UNIT PATENT APPLICATION ant Commissioner for Patents ngton, D.C. 20231 Please record the attached original document	04-2002	PATENT APPLICATION Attorney's Do. No. 9898-208 ARK OFFICE	
	1.	Name of party(ies) conveying an interest:	Ki-W	on CHOI	
	2.	Name and address of party(ies) receiving an int	erest: Sams 416 N	ung Electronics Co., Ltd. Iaetan-dong, Paldal-ku, Suwon-City gki-do KOREA	
	3.	Description of the interest conveyed:			
	 Assignment Change of Name Security Agreement Merger Date of execution of attached document: January 4, 2002 Application number(s) or patent number(s). Additional sheet attached? Yes No 				
If this document is being filed together with a new application, the execution date of the application				tion date of the application is: January 22, 2002	
		A. Patent Application No.	B. Pat	tent No.	
	5.	Name and address of party to whom correspondence concerning document should be mailed:			
		MARGER JOHNSON & McCOLLOM, P.C. 1030 S.W. Morrison Street Portland, Oregon 97205 Telephone: (503) 222-3613			
	6. Number of applications and patents involved: 1				
	 PTO Form 2038 authorizing credit card payment (\$40) is enclosed. Any deficiency or overpayment should be charged or credited to deposit account number 13-1703. 				
	9.	To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.			
{	FC:581 MARC 1030 S Portlar	Dated: January 22, 2002 RMEBRAHT 00000049 10055266 40.00 DP GER JOHNSON & McCOLLOM, P.C. W Morrison Street ad, OR 97205 222-3613	Alan T. McCo Reg. No. 28,8 Total	HNSON & McCOLLOM, P.C.	

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PATENT APPLICATION Atty's Do. No. 9898-208 Y.P. Lee Ref. No.:SS-15400-US

ASSIGNMENT

U.S.A. Patent Application Sole or Joint For Inventions Made Outside U.S.A. Executed With Application

In consideration of the sum of Ten Dollars (10.00) and other good and valuable considerations paid to each of the undersigned, to wit:

(1) Ki-won CHOI

the receipt and sufficiency of which are hereby acknowledged by the undersigned who hereby sell(s), assign(s) and transfer(s) unto:

SAMSUNG ELECTRONICS CO., LTD. 416 MAETAN-DONG, PALDAL-KU SUWON-CITY, KYUNGKI-DO REPUBLIC OF KOREA

(hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States Of America as defined in 35 U.S.C. §1.00, in and to the invention known as:

SEMICONDUCTOR PACKAGE HAVING CHANGED SUBSTRATE DESIGN USING SPECIAL WIRE BONDING

for which an application for Letters Patent of the United States of America has been executed even date herewith by the undersigned, and in and to any and all divisionals, continuations, substitutes, and reissues thereof; and all resulting patents and the undersigned hereby authorizes and requests the United States Assistant Commissioner of Patents to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

And the undersigned hereby agrees to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE'S full protection and title in and to the invention hereby transferred.

PATENT REEL: 012523 FRAME: 0649

Please sign concurrently with Oath or Declaration and Power of Attorncy

SIGNED ON THE DATES INDICATED BESIDE OUR SIGNATURES:

INVENTOR(S)

DATE SIGNED

WITNESSED

(1) <u>K/-L04/ (H0/</u> Ki-won CHOI 01.04. 2002

PLEASE RETURN RECORDED ASSIGNMENT TO:

Alan T. McCollom Marger Johnson & McCollom 1030 S.W. Morrison Street Portland, OR 97205